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## 144 nA I<sub>Q</sub> Low Quiescent Current Buck DC/DC Converter for Energy Harvester Evaluation Board

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No. EEV-414-K009A-230403

R1800K009A-EV is the evaluation board for R1800 which has the below features, benefits and specification.

### OVERVIEW

R1800K is a power-storing buck DC/DC converter for a photovoltaic and vibration energy harvester. A low operating quiescent current allows a harvester to be used under a low-illumination environment, and it is suitable for power management of an energy harvester with a low power sensor system.

### KEY BENEFITS

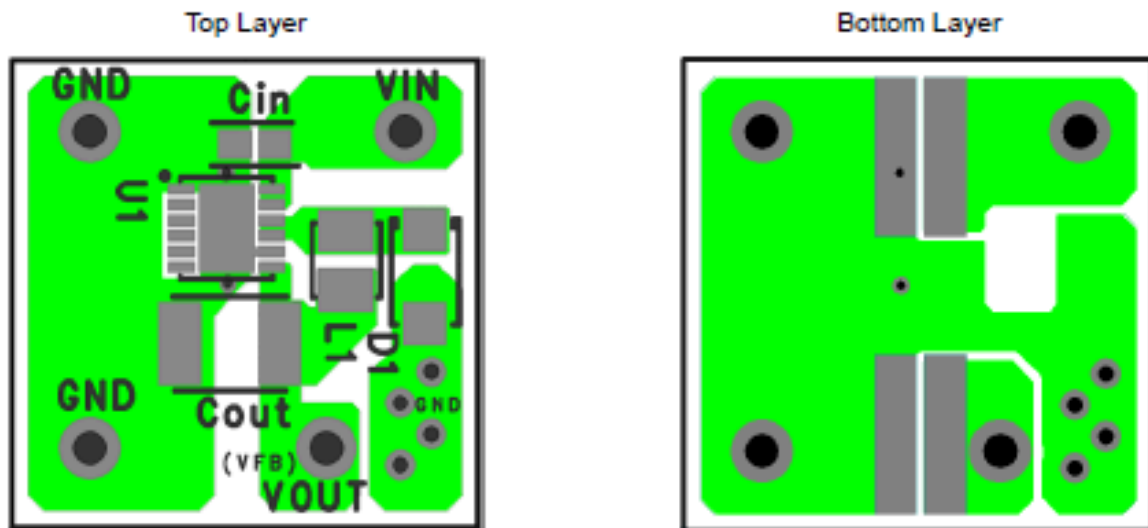
- Providing a low operating quiescent current (I<sub>Q</sub> 144 nA) and a high efficiency (approximately 90% @ 10 μA).
- A Control function that enables a maximum power optimizes a power supply from an energy harvester.

### KEY SPECIFICATIONS

- Input Voltage Range: 2.0 V to 5.5 V
- Output Voltage Range: 2.0 V to 4.5 V
- Output Voltage Accuracy: ±3.0%
- Operating Quiescent Current: Typ. 144 nA (T<sub>a</sub> = 25°C, at no load)
- Starting Power: 720 nW
- Reverse Current Protection (V<sub>IN</sub> ≥ 2.0 V)
- Accuracy of Maximum Power Voltage: 200 mV
- For more details on R1800 IC, please refer to <https://www.nisshinbo-microdevices.co.jp/en/products/dc-dc-switching-regulator/spec/?product=r1800>

## PCB LAYOUT

R1800KxxxA-TR (PKG: DFN(PL)2730-12)



## ABSOLUTE MAXIMUM RATINGS

### Absolute Maximum Ratings

(GND = 0 V)

Symbol	Parameter	Rating	Unit
$V_{IN}$	VIN Pin Voltage	-0.3 to 6.5	V
$V_{LX}$	LX Pin Voltage	-0.3 to $V_{IN} + 0.3$	V
$V_{VFB}$	VFB Pin Voltage	-0.3 to 6.5	V
$P_D$	Power Dissipation <sup>(1)</sup> [ DFN(PL)2730-12, JEDEC STD. 51-7 Test Land Pattern ]	1850	mW
$T_j$	Junction Temperature Range	-40 to 85	°C
$T_{stg}$	Storage Temperature Range	-55 to 125	°C

### ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

## RECOMMENDED OPERATING CONDITIONS

### Recommended Operating Conditions

Symbol	Parameter	Rating	Unit
$V_{IN}$	Input Voltage	2.0 to 5.5	V
$T_a$	Operating Temperature Range	-40 to 85	°C

### RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

<sup>(1)</sup> Refer to *POWER DISSIPATION* for detailed information.

## ELECTRICAL CHARACTERISTICS

The specifications surrounded by   are guaranteed by design engineering at  $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$ .

### R1800K Electrical Characteristics

( $T_a = 25^{\circ}\text{C}$ )

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
$V_{\text{OUT}}$	Output Voltage	$V_{\text{IN}} \geq V_{\text{SET}} + 0.5 \text{ V}$ , at no load	<span style="border: 1px solid black; padding: 0 5px;">x 0.97</span>		<span style="border: 1px solid black; padding: 0 5px;">x 1.03</span>	V
$I_{\text{Q}}$	Operating Quiescent Current	$V_{\text{IN}} = 5.0 \text{ V}$ , $V_{\text{SET}} = 3.0 \text{ V}$ , device not switching		144	<span style="border: 1px solid black; padding: 0 5px;">300</span>	nA
$P_{\text{ST}}$	Minimum Starting Power	$T_a = 25^{\circ}\text{C}$ , $V_{\text{IN}} = 4 \text{ V}$ , $V_{\text{SET}} = 3.3 \text{ V}$ , when constant current is applied		720		nW
$V_{\text{MP}}$	Accuracy of Maximum Power Voltage				<span style="border: 1px solid black; padding: 0 5px;">200</span>	mV
$I_{\text{REV}}$	Reverse Current	$V_{\text{IN}} \geq 2.0 \text{ V}$ , $V_{\text{FB}} = 4.5 \text{ V}$ (When $V_{\text{IN}}$ drops from 2.5 V or more) Charging current to $C_{\text{IN}}$ and $C_{\text{OUT}}$ are not included <sup>(1)</sup>		10	<span style="border: 1px solid black; padding: 0 5px;">100</span>	nA

All test items listed under Electrical Characteristics are done under the pulse load condition ( $T_j \approx T_a = 25^{\circ}\text{C}$ ).  
Test circuit is operated with "Open Loop Control" (GND = 0 V), unless otherwise specified.

### Product-specific Electrical Characteristics

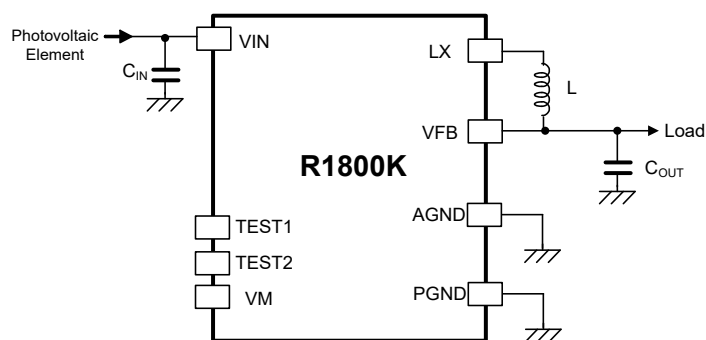
Product Name	$V_{\text{OUT}}$ [V]			$V_{\text{MP}}$ [V]	
	Min.	Typ.	Max.	Typ.	Max.
R1800K019A	<span style="border: 1px solid black; padding: 0 5px;">3.201</span>	3.3	<span style="border: 1px solid black; padding: 0 5px;">3.999</span>	4.0	<span style="border: 1px solid black; padding: 0 5px;">4.2</span>

$V_{\text{OUT}}$ : the set output voltage,  $V_{\text{MP}}$ : the set maximum power voltage

<sup>(1)</sup> Reverse current protection operates at  $V_{\text{IN}} \geq 2 \text{ V}$ . It does not function with the voltage under 2 V. Set as  $V_{\text{MPSET}} > V_{\text{SET}} + 0.5 \text{ V}$ . Due to having a hysteresis in the reverse current protection, a state may be detected as a reverse current even if  $V_{\text{IN}} = V_{\text{OUT}}$ .

## APPLICATION INFORMATION

### Typical Application Circuit



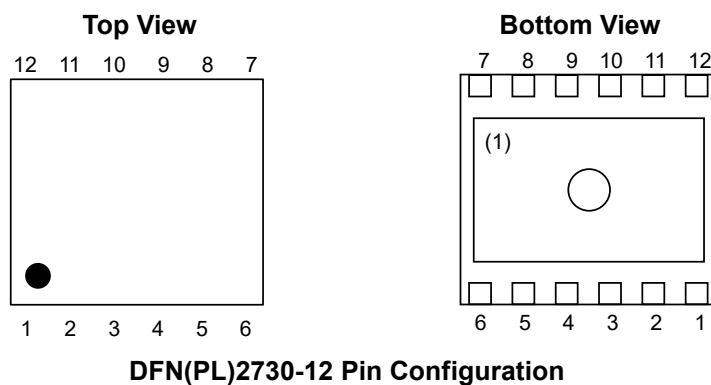
R1800K Typical Application Circuit

### Recommended External Components<sup>(1)</sup>

Symbol	Value
L	22 $\mu$ H
$C_{IN}$	10 $\mu$ F
$C_{OUT}$	47 $\mu$ F

<sup>(1)</sup>The bill of materials will be attached on the shipment of each purchased evaluation board.

## PIN DESCRIPTION



### DFN(PL)2730-12 Pin Description

Pin No.	Symbol	Description
1	AGND	AGND Pin
2	TEST1	Pin for Testing (Must not be connected)
3	TEST2	Pin for Testing (Must not be connected)
4	VM	Pin for Testing (Must not be connected)
5	NC	No Connection (Must not be connected)
6	NC	No Connection (Must not be connected)
7	VFB	Feedback Pin
8	PGND	PGND Pin
9, 10	LX	DC/DC Switching Pin
11, 12	VIN	Pin for Connecting Photovoltaic Element

<sup>(1)</sup> The tab on the bottom of the package enhances thermal performance and is electrically connected to GND (substrate level). It is recommended that the tab be connected to the ground plane on the board, or otherwise be left floating.

## TECHNICAL NOTES

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. A peripheral component or the device mounted on PCB should not exceed a rated voltage, a rated current or a rated power. When designing a peripheral circuit, please be fully aware of the following points.

- External components must be connected as close as possible to the IC and make wiring as short as possible. Especially, the capacitor connected in between  $V_{IN}$  pin and GND pin must be wiring the shortest.
- If their impedance is high, internal voltage of the IC may shift by the switching current, and the operating may be unstable. Make the power supply and GND lines sufficient.
- As for wirings of the power, the ground, the inductor, the LX and the VFB pins, due consideration must be given to large current occurred by switching.
- Please choose inductors which have low direct-current resistance, enough allowable current and low magnetic saturation. Current-limited circuit may operate with LX peak current before reaching expected load current in case of low allowable current and extremely low inductance value under load condition.
- Note that the current-limited circuit is self-heating and radiation environment sensitive.

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In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
  - 8-2. **Quality Warranty Remedies**

When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.

Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
  - 8-3. **Remedies after Quality Warranty Period**

With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
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